PMR205 Series Metallized Impregnated Paper, 125 VAC/250 VDC



Overview

The PMR205 Series is constructed of multilayer metallized paper encapsulated and impregnated in self-extinguishing material meeting the requirements of UL 94 V-0.

Applications

Typical applications include worldwide use in contact protection, contact interference suppression and transient suppression.

Benefits

- Rated voltage: 125 VAC/250 VDC, 50/60 Hz
- Capacitance range: 0.1 1.0 μF
- Capacitance tolerance: ±20%
- Resistance range: 22 680 Ω
- Resistance tolerance: ±30%
- Lead spacing: 15.2 25.4 mm
- Climatic category: 40/085/56/B, IEC 60068-1
- Tape and reel packaging in accordance with IEC 60286-2
- · RoHS Compliant and lead-free terminations
- Operating temperature range of -40°C to +85°C



PMR205	Α	В	6100	М	033	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Resistance (Ω)	Packaging
RC Snubber, Metallized Paper	A = 125	B = 15.2 C = 20.3 E = 25.4	The last three digits represent significant figures. The first digit specifies the total number of digits.	M = ±20%	Resistance Value in Ω	See Ordering Options Table

Legacy Part Number System

New KEMET Part Number System

Р	405	Q	E	104	М	125	Α	H330
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging	Resistance (Ω)
P = Metallized Paper	RC Snubber	Q = 15.2 C = 20.3 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	125 = 125	See Ordering Options Table	H plus first two digits represent significant figures. Third digit specifies number of zeros.

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Benefits cont'd

- Excellent self-healing properties which ensure long life even when subjected to frequent over voltages
- Good resistance to ionization due to impregnated paper dielectric
- High dV/dt capability
- Impregnated paper ensures excellent stability and reliability properties, particularly in applications with continuous operation

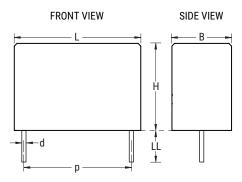
Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code	
	Standard Lead and Packaging Options				
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06	
	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30	
15.2	Tape & Reel (Standard Reel)	H _o = 18.5 +/-0.5	L	R19T0	
	Other Lead and Packaging Options				
	Tape & Reel (Large Reel)		Р	R19T1	
	Standard Lead and Packaging Options				
	Bulk (Tray) – Short Leads	6 +0/-1	С	R06	
	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30	
20.3	Tape & Reel (Standard Reel)	H _o = 18.5 +/-0.5	L	R19T0	
	Other Lead and Packaging Options				
	Tape & Reel (Large Reel)		Р	R19T1	
	Standard Lead and Packaging Options				
25.4	Bulk (Bag) – Short Leads	6 +0/-1	С	R06	
	Bulk (Tray) – Max Length Leads	30 +5/-0	А	R30	

Ordering Options Table





Dimensions – Millimeters



Size Code	р		В		Н		L		d	
Size Coue	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
QE	15.2	+/-0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	+/-0.05
QM	15.2	+/-0.4	7.3	Maximum	13.0	Maximum	18.5	Maximum	0.8	+/-0.05
QP	15.2	+/-0.4	7.8	Maximum	13.5	Maximum	18.5	Maximum	0.8	+/-0.05
CE	20.3	+/-0.4	7.6	Maximum	14.0	Maximum	24.0	Maximum	0.8	+/-0.05
CJ	20.3	+/-0.4	9.0	Maximum	15.0	Maximum	24.0	Maximum	0.8	+/-0.05
СР	20.3	+/-0.4	11.3	Maximum	16.5	Maximum	24.0	Maximum	0.8	+/-0.05
EE	25.4	+/-0.4	10.6	Maximum	16.1	Maximum	30.5	Maximum	1.0	+/-0.05
		1	lote: See Ord	ering Options 1	able for lead	length (LL) opt	ions.			



Performance Characteristics

125 VAC 50/60 Hz					
0.1 – 1.0 µF					
±20%					
22 - 680 Ω					
±30%					
-40°C to +85°C					
40/085/56/B					
375 V					
The series resistance is defined 100 kHz for RC < 50 µs	at 1 kHz for RC ≥ 50 µs and at				
Minimum Values E	Between Terminals				
C ≤ 0.33 µF	≥ 3,000 MΩ				
C > 0.33 µF	≥ 1,000 MΩ • μF				
temperature does not exceed + 8	85°C. For maximum permitted				
Temperature and Case Sizes.	Ipation Vs. Ambient 5 70 80 85 °C Dimension B (mm) 5.2 7.3 7.8 7.6 9 11.3				
	$22 - 680 \Omega$ $\pm 30\%$ $-40^{\circ}C to +85^{\circ}C$ $40/085/56/B$ $375 V$ The series resistance is defined 100 kHz for RC < 50 µs $C \le 0.33 µF$ $C > 0.33 µF$ The average losses may reach 0. temperature does not exceed + 8 power dissipation vs. temperatu Maximum Allowable Power Dissi Temperature and Case Sizes. $0.5 \frac{1}{0} \frac{1}{0} \frac{2}{0} \frac{4}{0} \frac{1}{0} $				



Environmental Test Data

Test	IEC Publication	Procedure
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 500 Hz at 0.75 mm or 98 m/s²
Bump	IEC 60068-2-29 Test Eb	4,000 bumps at 390 m/s ²
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.

Table 1 – Ratings & Part Number Reference

Lead Spacing (p)	Capacitance Value (µF)	Resistance (Ω)	Maxim	um Dimens mm	sions in	New KEMET Part Number	Legacy Part Number
Spacing (p)	value (µr)	(12)	В	Н	L	r alt Nullibei	
15.2	0.10	33	5.2	10.5	18.5	P405QE104M125(1)H330	PMR205AB6100M033(1)
15.2	0.10	47	5.2	10.5	18.5	P405QE104M125(1)H470	PMR205AB6100M047(1)
15.2	0.10	100	5.2	10.5	18.5	P405QE104M125(1)H101	PMR205AB6100M100(1)
15.2	0.10	220	5.2	10.5	18.5	P405QE104M125(1)H221	PMR205AB6100M220(1)
15.2	0.15	68	5.2	10.5	18.5	P405QE154M125(1)H680	PMR205AB6150M068(1)
15.2	0.15	100	5.2	10.5	18.5	P405QE154M125(1)H101	PMR205AB6150M100(1)
15.2	0.22	47	7.3	13.0	18.5	P405QM224M125(1)H470	PMR205AB6220M047(1)
15.2	0.22	100	7.3	13.0	18.5	P405QM224M125(1)H101	PMR205AB6220M100(1)
15.2	0.22	220	7.3	13.0	18.5	P405QM224M125(1)H221	PMR205AB6220M220(1)
15.2	0.22	330	7.3	13.0	18.5	P405QM224M125(1)H331	PMR205AB6220M330(1)
15.2	0.22	470	7.3	13.0	18.5	P405QM224M125(1)H471	PMR205AB6220M470(1)
15.2	0.25	200	7.3	13.0	18.5	P405QM254M125(1)H201	PMR205AB6250M200(1)
15.2	0.25	350	7.3	13.0	18.5	P405QM254M125(1)H351	PMR205AB6250M350(1)
15.2	0.25	600	7.3	13.0	18.5	P405QM254M125(1)H601	PMR205AB6250M600(1)
15.2	0.33	47	7.8	13.5	18.5	P405QP334M125(1)H470	PMR205AB6330M047(1)
20.3	0.47	22	7.6	14.0	24.0	P405CE474M125(1)H220	PMR205AC6470M022(1)
20.3	0.47	33	7.6	14.0	24.0	P405CE474M125(1)H330	PMR205AC6470M033(1)
20.3	0.47	47	7.6	14.0	24.0	P405CE474M125(1)H470	PMR205AC6470M047(1)
20.3	0.47	68	7.6	14.0	24.0	P405CE474M125(1)H680	PMR205AC6470M068(1)
20.3	0.47	100	7.6	14.0	24.0	P405CE474M125(1)H101	PMR205AC6470M100(1)
20.3	0.47	150	7.6	14.0	24.0	P405CE474M125(1)H151	PMR205AC6470M150(1)
20.3	0.47	220	7.6	14.0	24.0	P405CE474M125(1)H221	PMR205AC6470M220(1)
20.3	0.47	330	7.6	14.0	24.0	P405CE474M125(1)H331	PMR205AC6470M330(1)
20.3	0.47	470	9.0	15.0	24.0	P405CJ474M125(1)H471	PMR205AC6470M470(1)
20.3	0.47	680	11.3	16.5	24.0	P405CP474M125(1)H681	PMR205AC6470M680(1)
25.4	1.0	33	10.6	16.1	30.5	P405EE105M125(1)H330	PMR205AE7100M033(1)
20.3	1.0	47	11.3	16.5	24.0	P405CP105M125(1)H470	PMR205AC7100M047(1)
20.3	1.0	68	11.3	16.5	24.0	P405CP105M125(1)H680	PMR205AC7100M068(1)
20.3	1.0	100	11.3	16.5	24.0	P405CP105M125(1)H101	PMR205AC7100M100(1)
20.3	1.0	150	11.3	16.5	24.0	P405CP105M125(1)H151	PMR205AC7100M150(1)
20.3	1.0	220	11.3	16.5	24.0	P405CP105M125(1)H221	PMR205AC7100M220(1)
Lead Spacing (p)	Capacitance Value (µF)	Resistance Ω	B (mm)	H (mm)	L (mm)	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.



Soldering Process

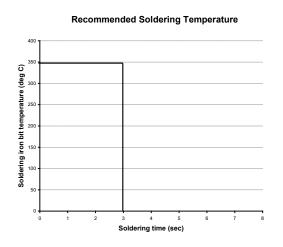
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

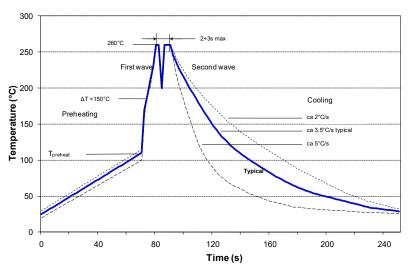
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

Wave Soldering Recommendations cont'd

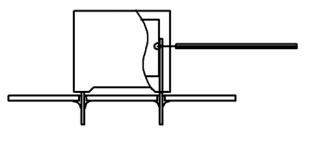
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Capacitor Capacitor Capacitor Pitch Pitch Pitch ≤ 10 mm = 15 mm > 15 mm		Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

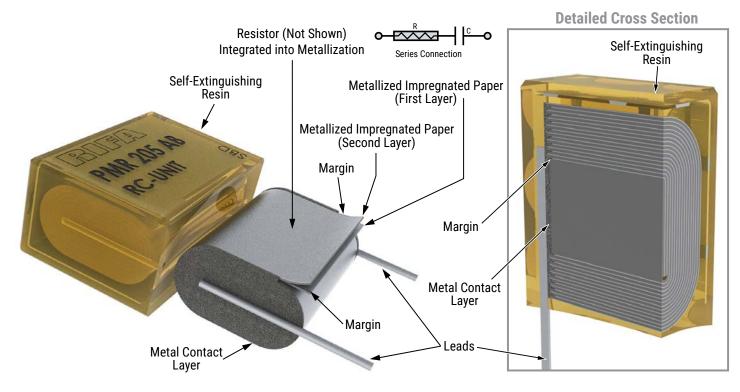
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

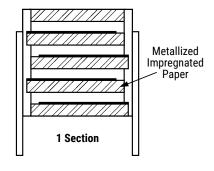
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Construction

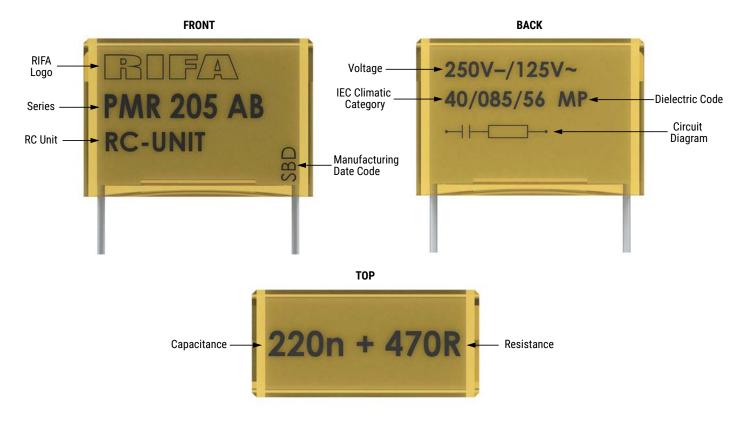


Winding Scheme





Marking



Packaging Quantities

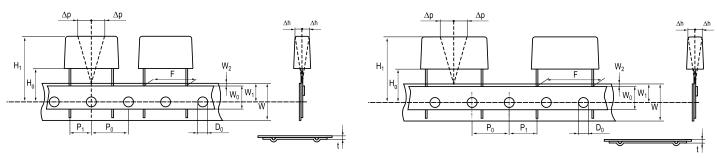
Size Code	Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 360 mm
QE	15.2	5.2	10.5	18.5	500	100	600
QM	15.2	7.3	13.0	18.5	400	800	400
QP	15.2	7.8	13.5	18.5	400	800	400
CE	20.3	7.6	14.0	24.0	250	1500	250
CJ	20.3	9.0	15.0	24.0	200	1200	250
СР	20.3	11.3	16.5	24.0	150	1000	180
EE	25.4	10.6	16.1	30.5	150	1000	



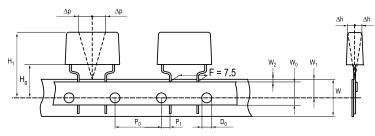
Lead Taping & Packaging (IEC 60286-2)

Lead Spacing 10.2 – 15.2 mm

Lead Spacing 20.3 – 22.5 mm



Formed Leads from 10.2 to 7.5 mm



Taping Specification

	Dimensions in mm										
Lead spacing	+6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F			
Carrier tape width	+/-0.5	W	18	18	18	18	18	18+1/-0.5			
Hold-down tape width	+/-0.3	W _o	9	12	12	12	12				
Position of sprocket hole	+/-0.5	W ₁	9	9	9	9	9	9+0.75/-0.5			
Distance between tapes	Maximum	W ₂	3	3	3	3	3	3			
Sprocket hole diameter	+/-0.2	D ₀	4	4	4	4	4	4			
Feed hole lead spacing	+/-0.3	P ₀ ⁽¹⁾	12.7(4)	12.7	12.7	12.7	12.7	12.7			
Distance lead – feed hole	+/-0.7	P ₁	3.75	7.6	5.1	8.9	5.3	P ¹			
Deviation tape – plane	Maximum	Δp	1.3	1.3	1.3	1.3	1.3	1.3			
Lateral deviation	Maximum	Δh	2	2	2	2	2	2			
Total thickness	+/-0.2	t	0.7	0.7	0.7	0.7	0.9 ^{max}	0.9 ^{max}			
Sprocket hole/cap body	Nominal	H ₀ ⁽²⁾	18+2/-0	18+2/-0	18+2/-0	18+2/-0	18.5+/-0.5	18+2/-0			
Sprocket hole/top of cap body	Maximum	H ₁ ⁽³⁾	35	35	35	35	58	58 ^{max}			

(1) Maximum cumulative feed hole error, 1 mm per 20 parts.(2) 16.5 mm available on request.

(3) Depending on case size.(4) 15 mm available on request.



Lead Taping & Packaging (IEC 60286-2) cont'd

Ammo Specifications

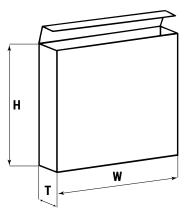
Series	Dimensions (mm)					
Series	Н	W	Т			
R4x, R4x+R, R7x, RSB						
F5A, F5B, F5D	360	340	59			
F6xx, F8xx						
PHExxx, PMExxx, PMRxxx	330	330	50			

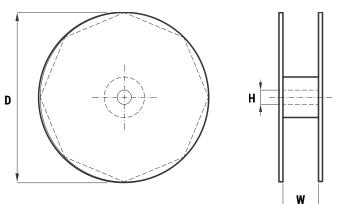
Reel Specifications

Corios	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055		
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	500	25	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)

Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month				
Year	Code	Month	Code	
2000	М	January	1	
2001	N	February	2	
2002	Р	March	3	
2003	R	April	4	
2004	S	May	5	
2005	Т	June	6	
2006	U	July	7	
2007	V	August	8	
2008	W	September	9	
2009	Х	October	0	
2010	А	November	Ν	
2011	В	December	D	
2012	С			
2013	D			
2014	E			
2015	F			
2016	Н			
2017	J			
2018	K			
2019	L			
2020	М			







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